Ultra-Fast Silicon Detector

• The “4D” challenge
• A parameterization of time resolution
• The “Low Gain Avalanche Detectors” project
• Laboratory measurements
• UFSD: LGAD optimized for timing measurements
• WeightField2: a simulation program to optimize UFSD
• First measurements
• Future directions

Nicolo Cartiglia

With
INFN Gruppo V, LGAD group of RD50, FBK and Trento University, Micro-Electronics Turin group
Rome2 - INFN.
Acknowledgement

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The 4D challenge

Is it possible to build a detector with concurrent excellent time and position resolution?

Can we provide in the same detector and readout chain:

- Ultra-fast timing resolution [\( \sim 10\ \text{ps} \)]
- Precision location information [10’s of \( \mu \text{m} \)]
Our path: Ultra-fast Silicon Detectors

Is it possible to build a silicon detector with concurrent excellent timing and position resolutions?

Why silicon?

- It already has excellent position resolution
- Very well supported in the community
- Finely segmented
- Thin
- Light
- A-magnetic
- Small
- Radiation resistant

But can it be precise enough?
A time-tagging detector

(a simplified view)

Time is set when the signal crosses the comparator threshold

The timing capabilities are determined by the characteristics of the signal at the output of the pre-Amplifier and by the TDC binning.
Noise source: Time walk and Time jitter

**Time walk:** the voltage value $V_{th}$ is reached at different times by signals of different amplitude.

**Jitter:** the noise is summed to the signal, causing amplitude variations.

Due to the physics of signal formation

$$\sigma_T^2 = \sigma_{Jitter}^2 + \sigma_{Time \ Walk}^2 + \sigma_{TDC}^2$$

Mostly due to electronic noise.

$$\sigma_J = \frac{N}{S/t_r}$$
Time Resolution and slew rate

Using the expressions in the previous page, we can write

$$\sigma_t^2 = \left( \left\{ \frac{V_{th}}{S/t_r} \right\}_{\text{RMS}} \right)^2 + \left( \frac{N}{S/t_r} \right)^2 + \left( \frac{TDC_{\text{bin}}}{\sqrt{12}} \right)^2$$

where:
- $S/t_r = dV/dt = \text{slew rate}$
- $N = \text{system noise}$
- $V_{th} = 10 \, N$

Assuming constant noise, to minimize time resolution we need to maximize the $S/t_r$ term (i.e. the slew rate $dV/dt$ of the signal)

⇒ We need large and short signals ⇐
Signal formation in silicon detectors

We know we need a large signal, but **how is the signal formed?**

A particle creates charges, then:
- The charges start moving under the influence of an external field
- The motion of the charges induces a current on the electrodes
- The signal ends when the charges reach the electrodes

What is controlling the slew rate?

\[
\frac{dV}{dt} \propto ?
\]

\(d\) \(V\) \(d\) \(t\) \(\propto\)
How to make a **good** signal

Signal shape is determined by Ramo’s Theorem:

$$i \propto qvE_w$$

A key to good timing is the uniformity of signals:

**Drift velocity** and **Weighting field** need to be **as uniform as possible**
Drift Velocity

\[ i \propto q v E_w \]

- Highest possible \( E \) field to saturate velocity
- Highest possible resistivity for velocity uniformity

We want to operate in this regime
Weighting Field: coupling the charge to the electrode

\[ i \propto qvE_w \]

Strip: 100 µm pitch, 40 µm width

Pixel: 300 µm pitch, 290 µm width

Bad: almost no coupling away from the electrode

Good: strong coupling almost all the way to the backplane

The weighting field needs to be as uniform as possible, so that the coupling is always the same, regardless of the position of the charge.
Non-Uniform Energy deposition

**Landau Fluctuations** cause two major effects:
- Amplitude variations, that can be corrected with time walk compensation
- For a given amplitude, the charge deposition is non uniform.

These are 3 examples of this effect:
What is the signal of one e/h pair?

(Simplified model for pad detectors)

Let’s consider one single electron-hole pair. The integral of their currents is equal to the electric charge, q:

\[ \int [i_{el}(t) + i_h(t)] dt = q \]

However the shape of the signal depends on the thickness d: thinner detectors have higher slew rate.

\[ i(t) \]

\[ i(t) \propto qv \frac{1}{d} \]

⇒ One e/h pair generates higher current in thin detectors.

Weighting field
Large signals from thick detectors?

(Simplified model for pad detectors)

Thick detectors have higher number of charges:

\[ Q_{\text{tot}} \sim 75 \, q \cdot d \]

However each charge contributes to the initial current as:

\[ i \propto q \frac{1}{d} \]

The initial current for a silicon detector does not depend on how thick (d) the sensor is:

\[ i = Nq \frac{k}{d} v = (75d/q) \frac{k}{d} v = 75kqv \sim 1 - 2 \times 10^{-6} A \]

\( \Rightarrow \) Initial current = constant

Number of e/h = 75/micron

Weighting field

velocity
Thin vs Thick detectors

(Simplified model for pad detectors)

Thin detector

Thick detector

\[ \frac{dV}{dt} \sim \frac{S}{t_r} \sim \text{const} \]

Thick detectors have longer signals, not higher signals

Best result: NA62, 150 ps on a 300 x 300 micron pixels

To do better, we need to add gain
The “Low-Gain Avalanche Detector” project

Is it possible to manufacture a silicon detector that looks like a normal pixel or strip sensor, but with a much larger signal (RD50)?

- 750 e/h pair per micron instead of 75 e/h?
- Finely Segmented
- Radiation hard
- No dead time
- Very low noise (low shot noise)
- No cross talk
-Insensitive to single, low-energy photon

Many applications:

- Low material budget (30 micron == 300 micron)
- Excellent immunity to charge trapping (larger signal, shorter drift path)
- Very good S/N: 5-10 times better than current detectors
- Good timing capability (large signal, short drift time)
Gain in Silicon detectors

Gain in silicon detectors is commonly achieved in several types of sensors. It's based on the avalanche mechanism that starts in high electric fields: $E \sim 300 \text{ kV/cm}$

Charge multiplication

$$N(l) = N_0 \cdot e^{\alpha l}$$

Gain:

$$G = e^{\alpha l}$$

$\alpha = \text{strong E dependance}$

$\alpha \sim 0.7 \text{ pair/}\mu\text{m for electrons,}$

$\alpha \sim 0.1 \text{ for holes}$

Concurrent multiplication of electrons and holes generate very high gain

Silicon devices with gain:

- APD: gain 50-500
- SiPM: gain $\sim 10^4$
How can we achieve $E \approx 300kV/cm$?

1) Use external bias: assuming a 300 micron silicon detector, we need $V_{\text{bias}} = 30kV$

Not possible

2) Use Gauss Theorem:

$$\sum q = 2\pi r \times E$$

$E = 300kV/cm \Rightarrow q \approx 10^{16}/cm^3$
Low Gain Avalanche Detectors (LGADs)

The LGAD sensors, as proposed and manufactured by CNM (National Center for Micro-electronics, Barcelona):

High field obtained by adding an extra doping layer

E \approx 300 \text{kV/cm}, closed to breakdown voltage
Why low gain? Can we use APD or SiPM instead?

My personal conclusion: I think it’s possible to obtain very good timing: APDs, SiPMs have very high gain, so they are excellent in “single shot” timing.

However, we are seeking to obtain something more powerful: a very low noise, finely pixelated device, able to provide excellent timing in any geometry, and also able to work in the presence of many low energy photons without giving fake hits.

These requirements make the use of high gain devices challenging
CNM, within the RD50 project, manufactured several runs of LGAD, trying a large variety of geometries and designs.

This implant controls the value of the gain.

<table>
<thead>
<tr>
<th>Wafer Number</th>
<th>P-layer Implant (E = 100 keV)</th>
<th>Substrate features</th>
<th>Expected Gain</th>
</tr>
</thead>
<tbody>
<tr>
<td>1-2</td>
<td>$1.6 \times 10^{13}$ cm$^{-2}$</td>
<td>HRP 300 (FZ; $\rho &gt; 10$ K$\Omega \cdot$cm; $&lt;100&gt;$; T = 300±10 μm)</td>
<td>2 – 3</td>
</tr>
<tr>
<td>3-4</td>
<td>$2.0 \times 10^{13}$ cm$^{-2}$</td>
<td>HRP 300 (FZ; $\rho &gt; 10$ K$\Omega \cdot$cm; $&lt;100&gt;$; T = 300±10 μm)</td>
<td>8 – 10</td>
</tr>
<tr>
<td>5-6</td>
<td>$2.2 \times 10^{13}$ cm$^{-2}$</td>
<td>HRP 300 (FZ; $\rho &gt; 10$ K$\Omega \cdot$cm; $&lt;100&gt;$; T = 300±10 μm)</td>
<td>15</td>
</tr>
<tr>
<td>7</td>
<td>(---) PiN Wafer</td>
<td>HRP 300 (FZ; $\rho &gt; 10$ K$\Omega \cdot$cm; $&lt;100&gt;$; T = 300±10 μm)</td>
<td>No Gain</td>
</tr>
</tbody>
</table>
The LGAD approach can be extended to any silicon structure, not just pads.

This is an example of LGAD strips.
Sensor: Simulation

We developed a full sensor simulation to optimize the sensor design

WeightField2, F. Cenna, N. Cartiglia 9th Trento workshop, Genova 2014
Available at http://personalpages.to.infn.it/~cartiglia/weightfield2

It includes:

- Custom Geometry
- Calculation of drift field and weighting field
- Currents signal via Ramo’s Theorem
- Gain
- Diffusion
- Temperature effect
- Non-uniform deposition
- Electronics
WeightField2: a program to simulate silicon detectors
WeightField2: output currents
WeightField2: response of the read-out electronics
How gain shapes the signal

Initial electron, holes

Gain electron: absorbed immediately
Gain holes: long drift home

Electrons multiply and produce additional electrons and holes.
- Gain electrons have almost no effect
- Gain holes dominate the signal

⇒ No holes multiplications
**Interplay of gain and detector thickness**

**The rate of particles** produced by the gain does not depend on $d$ (assuming saturated velocity $v_{\text{sat}}$)

$$dN_{\text{Gain}} \propto 75(v_{\text{sat}} \, dt)G$$

$\rightarrow$ **Constant rate of production**

However the initial value of the gain current depends on $d$ (via the weighing field)

$$di_{\text{gain}} \propto dN_{\text{Gain}} q v_{\text{sat}} \left( \frac{k}{d} \right) \rightarrow \text{Gain current } \sim \frac{1}{d}$$

A given value of gain has much more effect on thin detectors
Gain current vs Initial current

\[
\frac{d}{i} \propto \frac{dN_{\text{Gain}} q v_{\text{sat}} k}{k q v_{\text{sat}}} = \frac{75(v_{\text{sat}} dt) G q v_{\text{sat}} k}{k q v_{\text{sat}}} \propto \frac{G}{d} dt
\]

⇒ Go thin!!

(Real life is a bit more complicated, but the conclusions are the same)

Full simulation
(assuming 2 pF detector capacitance)

300 micron: ~ 2-3 improvement with gain = 20

Significant improvements in time resolution require thin detectors
Ultra Fast Silicon Detectors

UFSD are LGAD detectors optimized to achieve the best possible time resolution

Specifically:

1. Thin to maximize the slew rate (dV/dt)
2. Parallel plate – like geometries (pixels..) for most uniform weighting field
3. High electric field to maximize the drift velocity
4. Highest possible resistivity to have uniform E field
5. Small size to keep the capacitance low
6. Small volumes to keep the leakage current low (shot noise)
First Measurements and future plans

LGAD laboratory measurements
- Doping concentration
- Gain
- Time resolution measured with laser signals

LGAD Testbeam measurements
- Landau shape at different gains
- Time resolution measured with MIPs
### LGAD Sensors in Torino

**Thickness:** 300 µm

<table>
<thead>
<tr>
<th>Run</th>
<th>Sensor</th>
<th>P-Layer Implant (E=100 KeV)</th>
<th>Gain</th>
<th>$V_{break}$</th>
<th>Metal Layer</th>
</tr>
</thead>
<tbody>
<tr>
<td>6474</td>
<td>W8_B4</td>
<td>?</td>
<td>~ 10</td>
<td>&gt; 500 V</td>
<td>DR</td>
</tr>
<tr>
<td>6474</td>
<td>W8_C6</td>
<td>?</td>
<td>~ 10</td>
<td>&gt; 500 V</td>
<td>DC</td>
</tr>
<tr>
<td>6474</td>
<td>W9_B6</td>
<td>No implant</td>
<td>No Gain</td>
<td>&gt; 500 V</td>
<td>DR</td>
</tr>
<tr>
<td>7062</td>
<td>W1_F3</td>
<td>$1.6 \times 10^{13}$ cm$^{-2}$</td>
<td>~ 1-2</td>
<td>&gt; 500 V</td>
<td>DR</td>
</tr>
<tr>
<td>7062</td>
<td>W3_H5</td>
<td>$2.0 \times 10^{13}$ cm$^{-2}$</td>
<td>~ 10</td>
<td>&gt; 500 V</td>
<td>DR</td>
</tr>
<tr>
<td>7062</td>
<td>W7_D7</td>
<td>No implant</td>
<td>No Gain</td>
<td>&gt; 500 V</td>
<td>DR</td>
</tr>
</tbody>
</table>
Doping profile from CV measurement - I

\[ \frac{1}{C^2} = \frac{1}{N} \left( \frac{2}{A^2 q_0 \varepsilon_r} \right) * V \]

\[ N = \frac{2}{q_0 \varepsilon_r A^2} \frac{d\left(1/C^2\right)}{dV} \]

No-gain sensor

Doping profile
Doping profile from CV measurement - II

This “bump” creates the high field needed for the gain.
Using laser signals we are able to measure the different responses of LGAD and traditional sensors.
The gain is estimated as the ratio of the output signals of LGAD detectors to that of traditional one.

The gain increases linearly with Vbias (not exponentially!)

\[
\frac{\text{Gain @ 800V}}{\text{Gain @ 400V}} \approx 2
\]
Laser Measurements on CNM LGAD

We use a 1064 nm picosecond laser to emulate the signal of a MIP particle (without Landau Fluctuations)

The signal output is read out by either a Charge sensitive amplifier or a Current Amplifier (Cividec)

\[ \sigma_t \sim 140 \text{ ps} @ 800 \text{ Volts} \]
In collaboration with Roma2, we went to Frascati for a testbeam using 500 MeV electrons.

As measured in the lab, the gain ~ doubles going from 400 -> 800 Volt.

\[
\frac{\text{Gain @ 800V}}{\text{Gain @ 400V}} \sim \frac{11.2}{6.5} \sim 1.7
\]

The gain mechanism preserves the Landau amplitude distribution of the output signals.
Testbeam Measurements on CNM LGAD

Time difference between two LGAD detectors crossed by a MIP

Tested different types of electronics (Rome2 SiGe, Cividec), Not yet optimized for these detectors

$\sigma_t \sim 190 \text{ ps at 800 Volts}$
Present results and future productions

With WF2, we can reproduce very well the laser and testbeam results.

Assuming the same electronics, and 1 mm$^2$ LGAD pad with gain 10, we can predict the timing capabilities of the next sets of sensors.
The effect of Landau fluctuations in a MIP signal are degrading the time resolution by roughly 30% with respect of a laser signal.
Irradiation tests

The gain decreases with irradiations:
\[ \text{at } 10^{14} \text{n/cm}^2 \text{ is 20% lower} \]

- Due to boron disappearance

What-to-do next:

Planned new irradiation runs (neutrons, protons), new sensor geometries

Use Gallium instead of Boron for gain layer (in production now)
Gain in finely segmented sensors

Segmentation makes the effect of gain more difficult to predict, and most likely very dependent on the hit position.

Moving the junction on the deep side allows having a very uniform multiplication, regardless of the electrode segmentation.

Gain layer position/doping

Not for LGAD
The ultimate time resolution will be obtained with a custom ASIC. However, we might split the position and the time measurements.
Using AC coupling to achieve segmentation

Standard n-in-p LGAD, with AC read-out

Very uniform field due to large pads,
Segmentation due to AC coupling pick-up
Electronics

To fully exploit UFSDs, dedicated electronics needs to be designed.

The signal from UFSDs is different from that of traditional sensors

Pads with no gain
Charges generated uniquely by the incident particle

Pads with gain
Current due to gain holes creates a longer and higher signal

Nicolo Cartiglia, INFN, Torino - UFSD - SLAC
There are two time constants at play:

- $T_{\text{Col}}$: the signal collection time (or equivalently the rise time)
- $\tau = R_{\text{in}} C_{\text{Det}}$: the time needed for the charge to move to the electronics

$\tau / T_{\text{Col}}$ increases $\Rightarrow \frac{dV}{dt}$ decreases $\Rightarrow$ Smoother current

Need to find the optimum balance
Electronics: What is the best pre-amp choice?

Current Amplifier

• Fast slew rate
• Higher noise
• Sensitive to Landau bumps

Integrating Amplifier

• Slower slew rate
• Quieter
• Integration helps the signal smoothing
What is the best “time measuring” circuit?

- **Constant Fraction Discriminator**
  The time is set when a fixed fraction of the amplitude is reached.

- **Time over Threshold**
  The amount of time over the threshold is used to correct for time walk.

- **Multiple sampling**
  Most accurate method, needs a lot of computing power.
This term, the detector current shot noise, depends on the gain

\[ Q_n^2 = (2eI_{\text{Det}} + \frac{4kT}{R_{\text{Bias}}} + i^2_{N\_\text{Amp}})FT_{s} + (4kTR_s + e^2_{N\_\text{Amp}})F_v \frac{C_{\text{Det}}^2}{T_s} + F_{vf}A_f C_{\text{Det}}^2 \]

2eI_{\text{Det}} * Gain  low gain!  This term dominates for short shaping time
Noise - II

NOISE DUE TO GAIN:
Excess noise factor:
low gain, very small k

\[ \text{ENF} = kG + \left(2 - \frac{1}{G}\right)(1 - k) \]

\( k = \text{ratio } h/e \text{ gain} \)

Low leakage current and low gain (~ 10) together with short shaping time are necessary to keep the noise down.
These new productions will allow a detailed exploration of the UFSD timing capabilities, including border effects between pads, and distance from the sensor edge.

**Timescale:**
- **Fall 2014:** 200 micron
- **Spring 2015:** 100 micron
- **Spring 2015:** 50 micron
Next Steps

1. Wafer Production
   200 micron thick sensors by Spring-2015
   100 and 50 micron thick sensors by Summer 2015.

2. Production of UFSD doped with Gallium instead of Boron.


4. UFSD are included in the CMS TDR CT-PPS as a solution for forward proton tagging.

5. Use of UFSD in beam monitoring for hadron beam. INFN patent and work on-going.

6. Interest in UFSD for 4D tracking at high luminosity.

7. Testbeam analyses just started. Results coming soon…
UFSD – Summary

We are just starting to understand the timing capability of UFSD

- Low-gain avalanche diodes offer silicon sensors with an enhanced signal amplitude
- The internal gain makes them ideal for accurate timing studies
- We developed a program, Weightfield2 to simulate the behaviors of LGAD and optimized them for fast timing (available at http://personalpages.to.infn.it/~cartigli/Weightfield2.0/)
- Use Gallium to explore a more radiation hard doping layer
- Thin detectors enhance the effect of gain, several productions in progress

We measured:
- A jitter of 40 ps for a 300-micron thick pad LGAD detectors
- Very good gain stability, amplitude follows Landau distribution

Timescale: 1 year to assess UFSD timing capabilities
Low-Gain Avalanche Detectors (LGAD)

Introduction and Motivation

LGAD Design

Fabrication of LGADs at CNM

Electrical Characterization

Optimization of the Gain Region

Gain Testing of LGADs

Gain in the LGAD

Mitigation of Radiation Damage

Conclusions

Acknowledgments

Weightfield2: a fast simulator for silicon and diamond detectors

Goal

The goal of this project is to create a fast simulator of the weight field generated by an imaging system. It computes the electric field and the charge distribution using beam tracking and field calculation methods, and it can be run in parallel to speed up the simulation.

Methods

The program is written in C++ and uses the VEP package for beam tracking. It is designed to be fast and easy to use and it should provide an accurate representation of the detector response.

Findings

Weightfield2 is able to compute the weight field and to perform analyzing and visualizing the simulation results. It can be run in parallel to speed up the simulation.

The Weightfield2 Graphical User Interface

References

Acknowledgments
Additional references

Several talks at the 22nd, 23rd and 24th RD50 Workshops:

23rd RD50: https://indico.cern.ch/event/265941/other-view?view=standard
22nd RD50: http://panda.unm.edu/RD50_Workshop/

9th Trento Workshop, Genova, Feb 2014.

F. Cenna “Simulation of Ultra-Fast Silicon Detectors”

N. Cartiglia “Timing capabilities of Ultra-Fast Silicon Detector”

Papers:


Backup
The “Low-Gain Avalanche Detector” project

Is it possible to manufacture a silicon detector that looks like a normal pixel or strip sensor, but with a much larger signal (RD50)?

- 730 e/h pair per micron instead of 73 e/h
- Finely segmented
- Radiation hard
- No dead time
- Very low noise (low shot noise)
- No cross talk

Poster Session IEEE N26-13
How can we progress? Need simulation

We developed a full simulation program to optimize the sensor design, WeightField2, (http://cern.ch/weightfield2)

It includes:

• Custom Geometry
• Calculation of drift field and weighting field
• Currents signal via Ramo’s Theorem
• Gain
• Diffusion
• Temperature effect
• Non-uniform deposition
• Electronics
Sensor thickness and slim edge

Rule: when the depletion volume reaches the edge, you have electrical breakdown.

It’s customary to assume that the field extends on the side by ~ 1/3 of the thickness.

\[ \text{edge} = k^* \text{ thickness} \]

- \( k = 1 \) very safe
- \( k = 0.5 \) quite safe
- \( K = 0.3 \) limit

By construction, thin detectors (~ 100 micron) might have therefore slim edge
State-of-the-art Timing Detectors

Timing detectors exploit very fast physics processes such as Cherenkov light emission or electronic avalanches to create prompt signals.

- These detectors measure time very accurately but locate particles with the precision of ~ 1 mm.
- Good timing is obtained by using a gain mechanism, either in the detector or in the electronics.

CMS/ATLAS

$\sigma_t \sim 20-30$ ps

$\sigma_x \sim 1-2$ mm

ALICE
Extremely good position detectors are currently in use in every major high energy physics experiment:

- Millions of channels
- Very reliable
- Very radiation hard

The timing capability is however limited to ~ 100-150 ps
(NA62 @CERN)